Target Specification

High Precision Hall-Effect Switch

TLE4906H

Version 1.6

Features

- 2.7V to 24V supply voltage operation
- Operation from unregulated power supply
- High sensitivity and high stability of the magnetic switching points
- High resistance to mechanical stress by Active Error Compensation
- Reverse battery protection (-18V)
- Superior temperature stability
- Peak temperatures up to 195°C without damage
- Low jitter (typ. 1µs)
- High ESD performance (±6kV HBM)
- Digital output signal
- Unipolar version
- SMD package P-SC59-3-2 (SOT-23 compatible)

Type	Ordering Code	Package
TLE4906H	t.b.d.	P-SC59-3-2

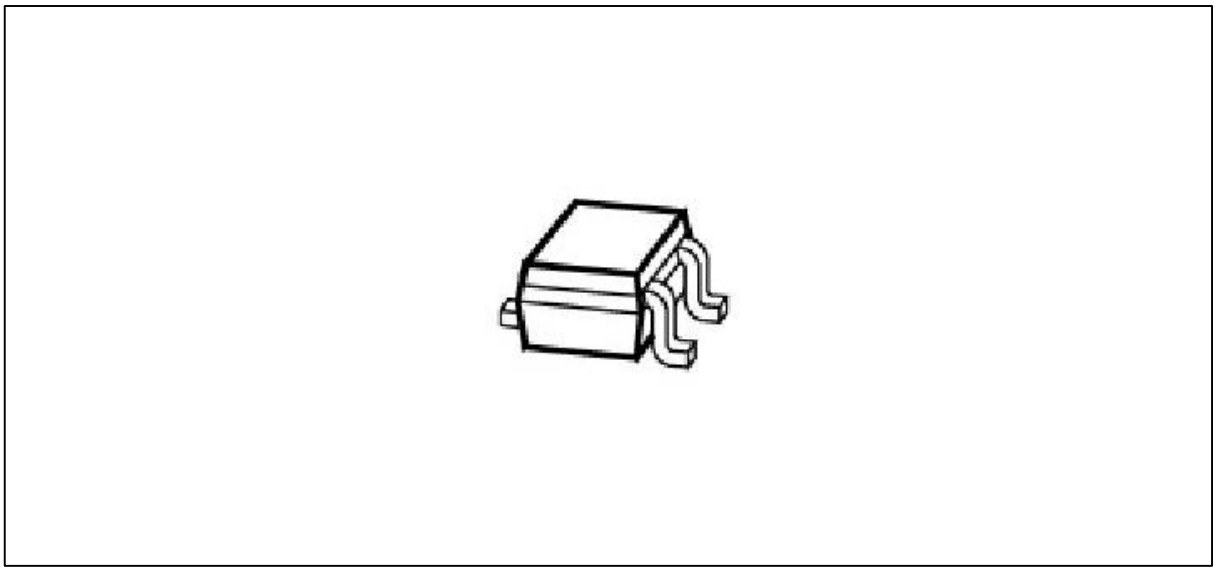

Figure 1: P-SC59-3-2

Functional Description

The TLE4906H is an integrated circuit Hall-effect sensor designed specifically for highly accurate applications. Precise magnetic switching points and high temperature stability are achieved by active compensation circuits and chopper techniques on chip.

Circuit Description

The chopped Hall IC Switch comprises a Hall probe, bias generator, compensation circuits, oscillator and output transistor.
The bias generator provides currents for the Hall probe and the active circuits. Compensation circuits stabilize the temperature behavior and reduce technology variations.

The Active Error Compensation rejects offsets in signal stages and the influence of mechanical stress to the Hall probe caused by molding and soldering processes and other thermal stresses in the package. This chopper technique together with the threshold generator and the comparator ensure high accurate magnetic switching points.

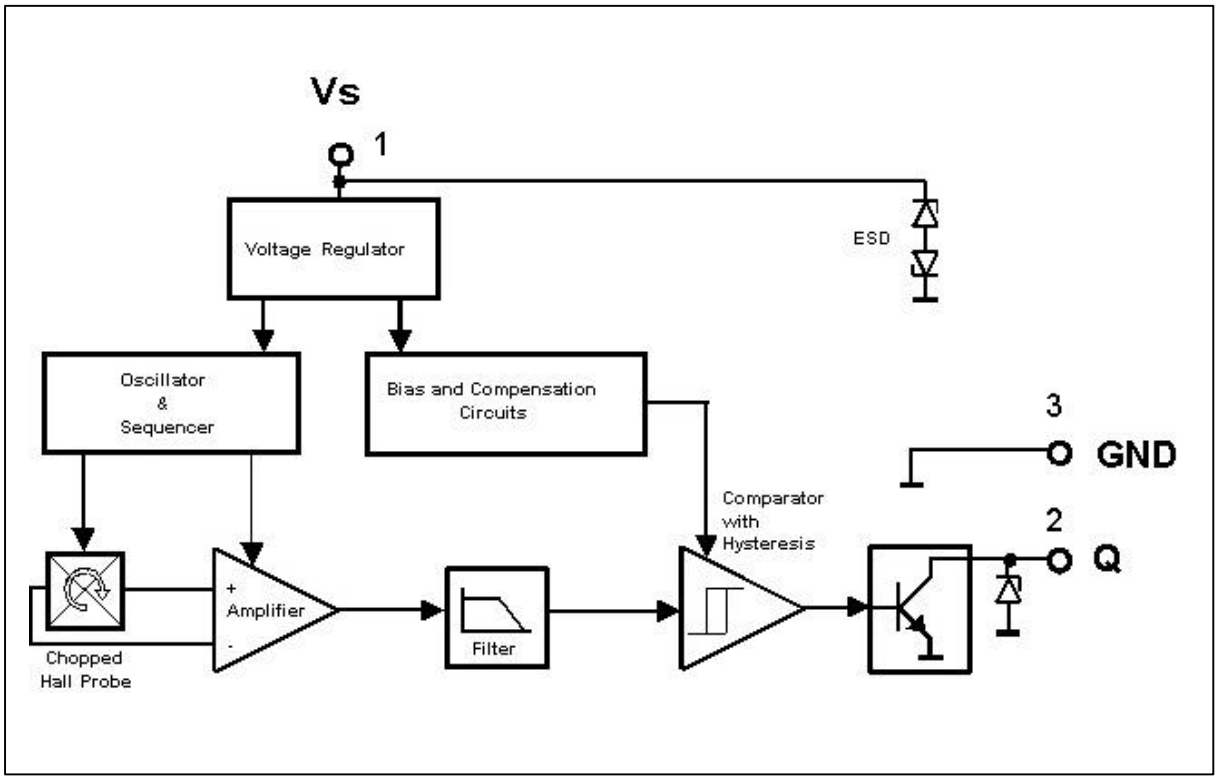

Figure 2: Block Diagram TLE4906H

Pin Configuration

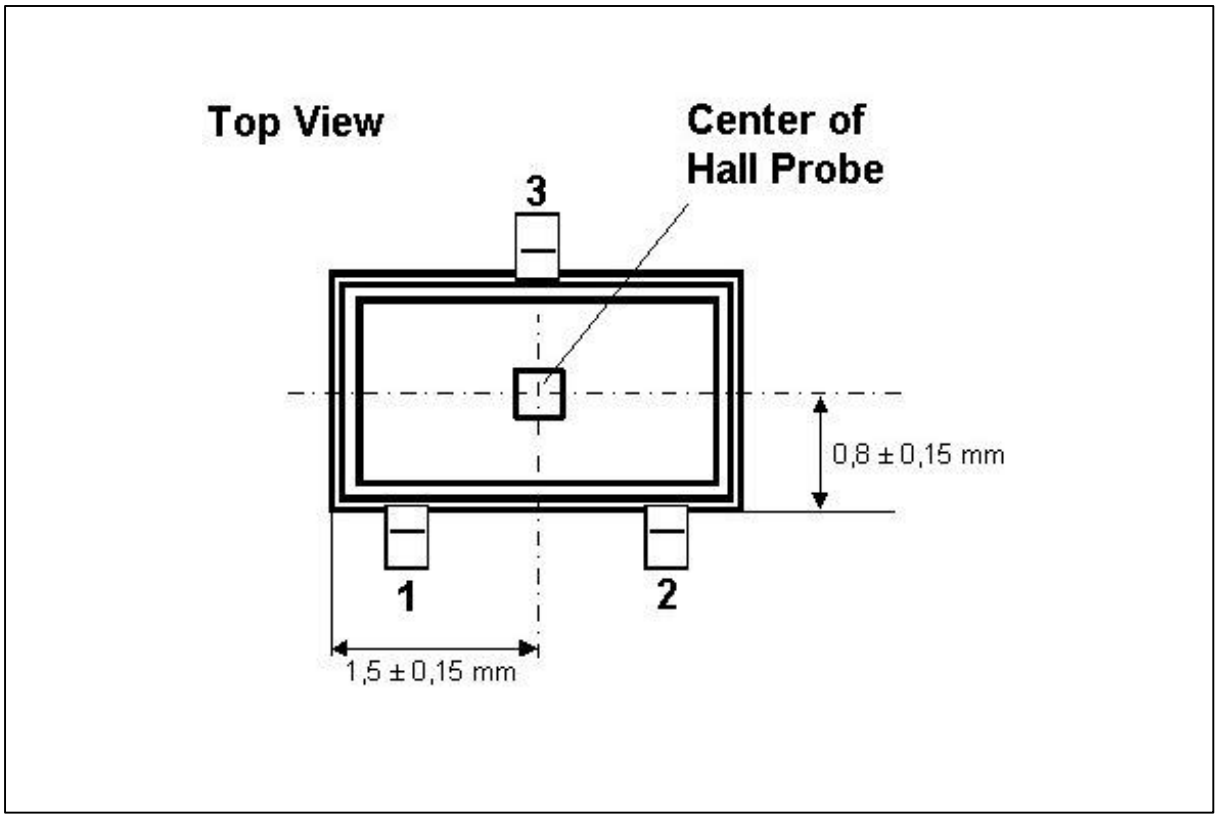

Figure 3: Pin Configuration TLE4906H (SOT-23 pin compatible)

Pin Definition and Functions

Pin	Symbol	Function
1	V_S	Supply voltage
2	Q	Output
3	GND	Ground

Absolute Maximum Ratings

Tj = -40 to 150°C

Parameter	Symbol	min.	max.	Unit	Conditions
Supply Voltage	V_S	-18 -18 -18	18 24 26	V	 for 1h ,Rs>=200 Ohm for 5min, Rs>=200 Ohm
Supply Current through protection device	I_S	-50	+50	mA	
Output Voltage	V_Q	-0.7 -0.7	18 26	V	 for 5 min @ 1.2 kOhm pull up
Continuous Output Current	I_Q	-50	+50	mA	
Junction Temperature	T_j	-	155 165 175 195	°C	for 2000 h (not additive) for 1000 h (not additive) for 168 h (not additive) for 3x1 h (additive)
Storage Temperature	T_S	-40	150	°C	
Magnetic Flux Density	B	-	unlimit.	mT	

Note: Stresses above those listed here may cause permanent damage to the device.
Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ESD Protection

Human Body Model (HBM) tests according to:
EOS/ESD Association Standard S5.1-1993 and Mil. Std. 883D method 3015.7

Parameter	Symbol	max.	Unit	Conditions
ESD Voltage	U_{ESD}	± 6	kV	HBM, R= 1.500 Ohm, C= 100pF; T_A= 25°C

Operating Range

Parameter	Symbol	min.	typ.	max.	Unit	Conditions
Supply Voltage	V_S	2.7	-	18 24 26	V	 1h with R_S >= 200 Ohm 5min with R_S >= 200 Ohm
Output Voltage	V_Q	-0.7	-	18	V	
Junction Temperature	T_j	-40	-	150 175	°C	 for 168 h
Output Current	I_Q	0	-	20	mA	

AC/DC Characteristics

over operating range, unless otherwise specified. Typical values correspond to V_S=12V and T_A=25°C.

Parameter	Symbol	min.	typ.	max.	Unit	Conditions
Supply Current	I_S	2	4	6	mA	V_S = 2.7V .. 18V
Reverse Current	I_{SR}	0	0.2	1	mA	V_Q=12V; V_S=-18V
Output Saturation Voltage	V_{QSAT}	-	0.3	0.6	V	I_Q= 20mA
Output Leakage Current	I_{LEAK}	-	0.05	10	µA	V_Q=18 V
Output Fall Time	t_f	-	0.02	1	µs	R_L= 1.2 kOhm ;C_L=50pF
Output Rise Time	t_r	-	0.4	1	µs	R_L= 1.2 kOhm ;C_L=50pF
Chopper Frequency	f_{OSC}	-	320	-	kHz	
Switching Frequency	f_{SW}	-	-	30 t.b.d.	kHz	Typ. value for B_{PP}=1.5*B_{HYS}
Delay Time[1)]	t_d	-	13	20 t.b.d.	µs	
Output Jitter[2)]	t_{QJ}	-	1	-	μs_{RMS}	Typ. Value for Square-Wave Signal 1kHz
Repeatability of magnetic thresholds[3)]	B_{REP}	-	20	-	μT_{RMS}	Typ. Value for $\Delta B/\Delta t$>12mT/ms
Power-On Time[4)]	t_{PON}	-	13	30	µs	V_S >= 2.7V
Thermal Resistance[5)] P-SC59-3-2	$R_{th\ JA}$	-	-	35	K/W	

[1)] Systematic delay between magnetic threshold reached and output switching.
[2)] Jitter is the unpredictable deviation of the output switching delay.
[3)] B_{REP} is equivalent to the noise constant.
[4)] Time from applying V_S >= 2.7V to the sensor until the output state is valid.
[5)] Thermal resistance from junction to ambient.
e.g. for V_S=2.7V, I_{Smax}=6mA, V_{QSAT}=0.4V and I_Q=20mA => Power Dissipation P_{dis}=24.2mW.
In $T_A = T_j – (R_{thJA} * P_{dis})$ = 175°C – (35 K/W * 0.0242 W) => $\underline{T_A = 174.2°C}$

Magnetic Characteristics

over operating range, unless otherwise specified. Typical values correspond to V_S=12V.

Parameter	Symbol	Tj [°C]	min.	typ.	max.	Unit	Conditions
Operate Point TLE4906H	B_{OP}	 -40 25 150	 6.7 6.5 6.2	 10.3 10.0 9.5	 13.9 13.5 12.9	mT	
Release Point TLE4906H	B_{RP}	 -40 25 150	 5.2 5.0 4.7	 8.7 8.5 8.1	 12.3 12.0 11.4	mT	
Hysteresis TLE4906H	B_{HYS}	 -40 25 150	 - 0.7 -	 - 1.5 -	 - 3.0 -	mT	
Temperature Compensation of Magnetic Thresholds	TC		-	-350	-	ppm/°C	

Positive magnetic fields related with south pole of magnet to the branded side of package.
Note: Typical characteristics specify mean values expected over the production spread.

Timing Diagram

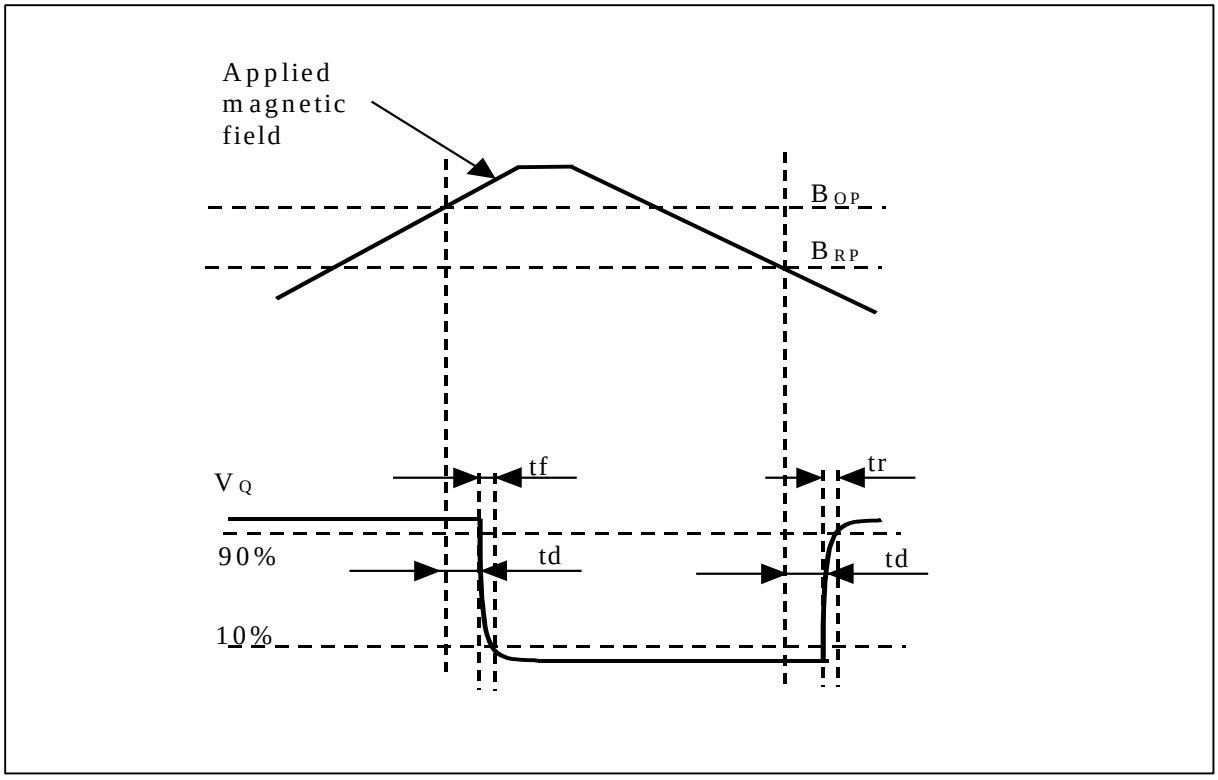

Figure 4: Timing definition of TLE4906H

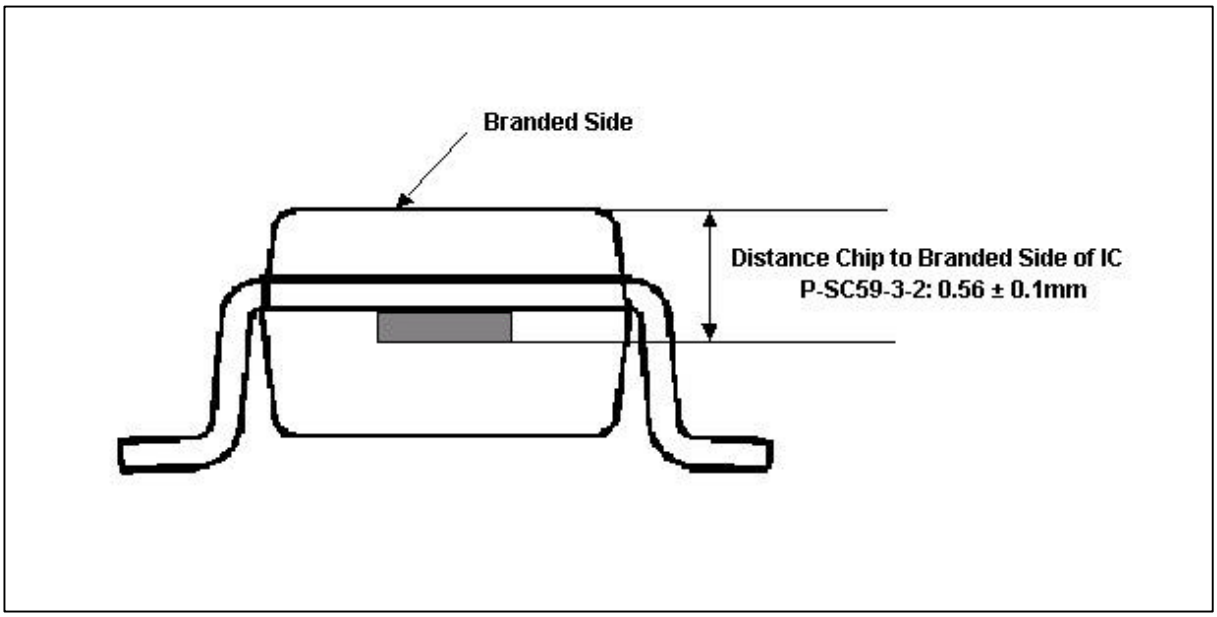

Figure 5: Distance from package to die

Package Dimension P-SC59-3-2

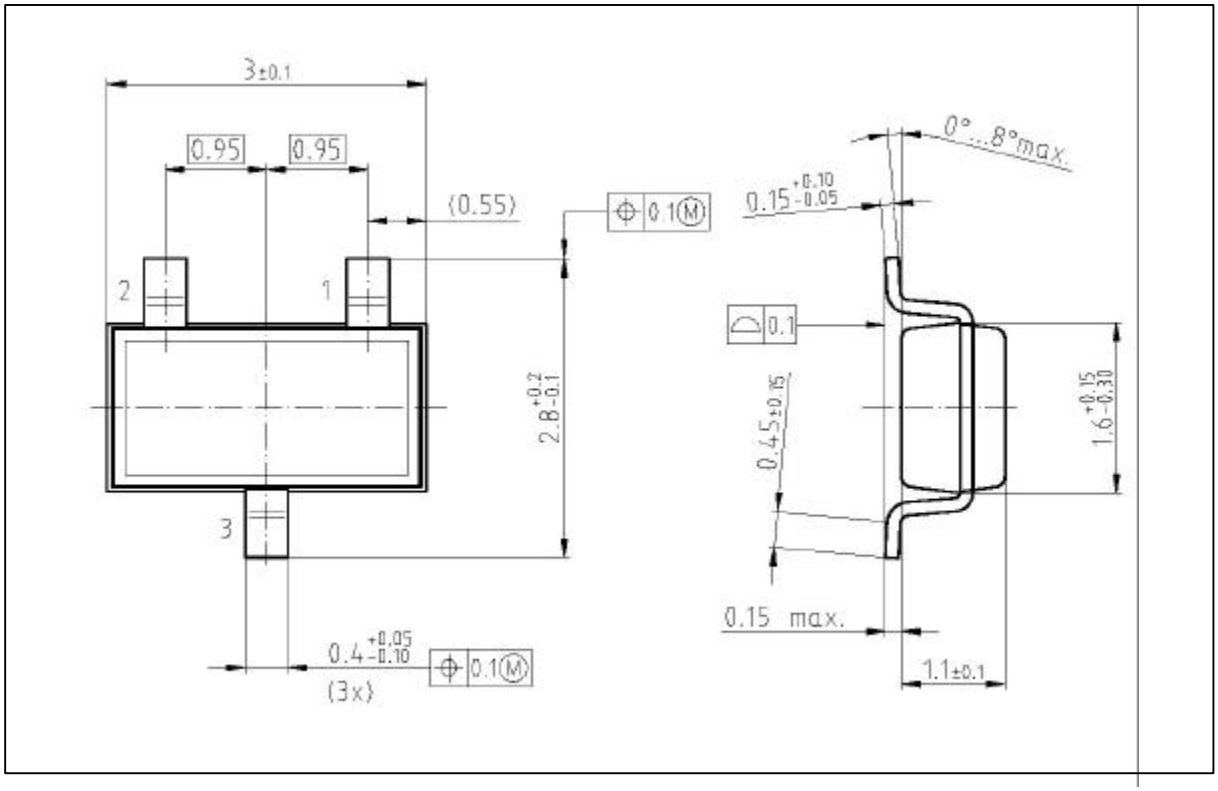

Figure 6: Package dimension TLE4906H

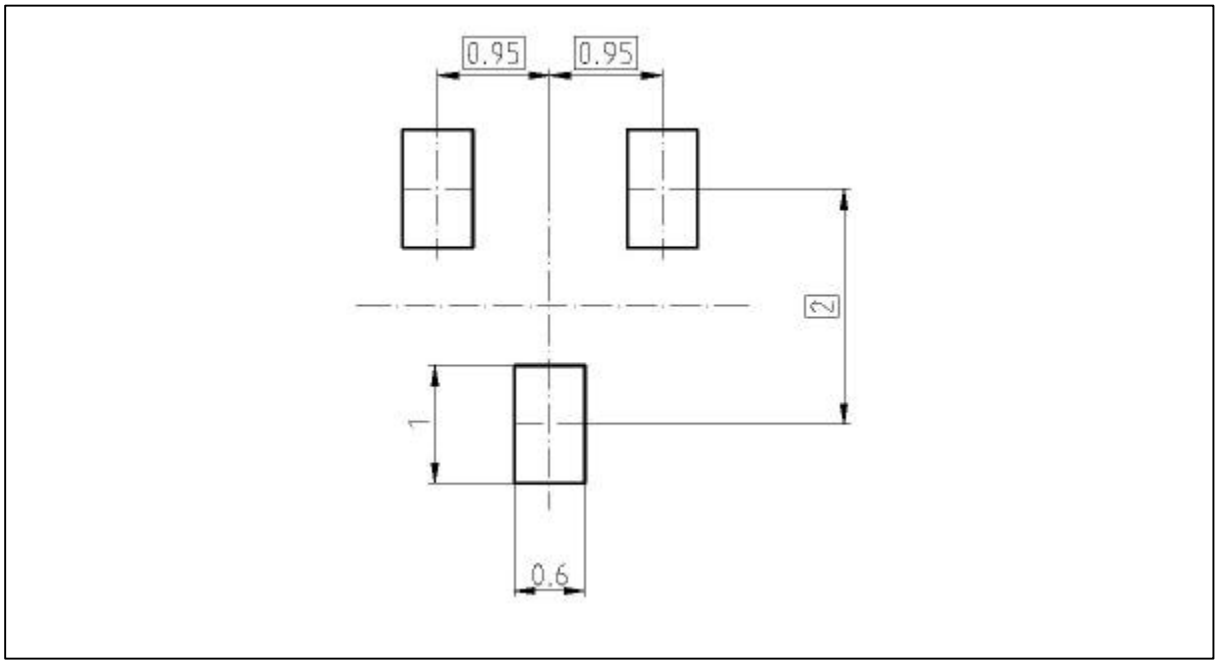

Figure 7: Foot print TLE4906H

TLE4906H **Revision History: 2003-02-21**	
Previous Version:	
Page	Subjects (major changes since last revision)

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